

N-Channel Power MOSFET

60V, 51A, 13mΩ

FEATURES

- Low $R_{DS(ON)}$ to minimize conductive losses
- Logic level
- Low gate charge for fast power switching
- 100% UIS and R_g tested.
- 175°C Operating Junction Temperature
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

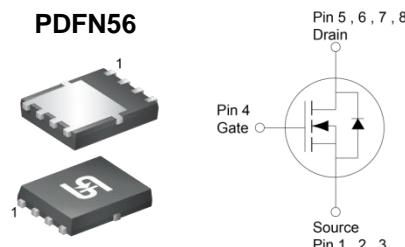
- BLDC Motor Control
- Battery Power Management
- DC-DC converter
- Secondary Synchronous Rectification

KEY PERFORMANCE PARAMETERS		
PARAMETER	VALUE	UNIT
V_{DS}	60	V
$R_{DS(on)}$ (max)	13	mΩ
	18	
Q_g	18	nC



ROHS
COMPLIANT

HALOGEN
FREE



Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)			
PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^(Note 1)	I_D	51	A
$T_C = 25^\circ C$		10	A
Pulsed Drain Current	I_{DM}	204	A
Single Pulse Avalanche Current ^(Note 2)	I_{AS}	20	A
Single Pulse Avalanche Energy ^(Note 2)	E_{AS}	60	mJ
Total Power Dissipation	P_D	83	W
$T_C = 125^\circ C$		28	W
Total Power Dissipation	P_D	3.1	W
$T_A = 25^\circ C$		1	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +175	°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Case Thermal Resistance	$R_{\Theta JC}$	1.8	°C/W
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	48	°C/W

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. The $R_{\Theta JA}$ limit presented here is based on mounting on a 1 in² pad of 2 oz copper.

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}$, $I_D = 250\mu\text{A}$	BV_{DSS}	60	--	--	V
Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\mu\text{A}$	$V_{GS(\text{TH})}$	1	1.7	2.5	V
Gate-Source Leakage Current	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$	I_{GSS}	--	--	± 100	nA
Drain-Source Leakage Current	$V_{GS} = 0\text{V}$, $V_{DS} = 60\text{V}$	I_{DSS}	--	--	1	μA
	$V_{GS} = 0\text{V}$, $V_{DS} = 60\text{V}$ $T_J = 125^\circ\text{C}$		--	--	100	
Drain-Source On-State Resistance <small>(Note 3)</small>	$V_{GS} = 10\text{V}$, $I_D = 10\text{A}$	$R_{DS(\text{on})}$	--	12	13	$\text{m}\Omega$
	$V_{GS} = 4.5\text{V}$, $I_D = 8\text{A}$		--	14	18	
Forward Transconductance <small>(Note 3)</small>	$V_{DS} = 10\text{V}$, $I_D = 10\text{A}$	g_{fs}	--	39	--	S
Dynamic <small>(Note 4)</small>						
Total Gate Charge	$V_{GS} = 10\text{V}$, $V_{DS} = 30\text{V}$, $I_D = 10\text{A}$	Q_g	--	37	--	nC
Total Gate Charge	$V_{GS} = 4.5\text{V}$, $V_{DS} = 30\text{V}$, $I_D = 8\text{A}$	Q_g	--	18	--	
Gate-Source Charge		Q_{gs}	--	7	--	
Gate-Drain Charge		Q_{gd}	--	9	--	
Input Capacitance	$V_{GS} = 0\text{V}$, $V_{DS} = 30\text{V}$ $f = 1.0\text{MHz}$	C_{iss}	--	2175	--	pF
Output Capacitance		C_{oss}	--	142	--	
Reverse Transfer Capacitance		C_{rss}	--	63	--	
Gate Resistance	$f = 1.0\text{MHz}$	R_g	0.5	1.5	3	Ω
Switching <small>(Note 4)</small>						
Turn-On Delay Time	$V_{GS} = 10\text{V}$, $V_{DS} = 30\text{V}$, $I_D = 10\text{A}$, $R_G = 2\Omega$	$t_{d(on)}$	--	2	--	ns
Turn-On Rise Time		t_r	--	19	--	
Turn-Off Delay Time		$t_{d(off)}$	--	23	--	
Turn-Off Fall Time		t_f	--	19	--	
Source-Drain Diode						
Forward Voltage <small>(Note 3)</small>	$V_{GS} = 0\text{V}$, $I_S = 10\text{A}$	V_{SD}	--	--	1	V
Reverse Recovery Time	$I_S = 10\text{A}$, $dI/dt = 100\text{A}/\mu\text{s}$	t_{rr}	--	15	--	ns
Reverse Recovery Charge		Q_{rr}	--	9	--	nC

Notes:

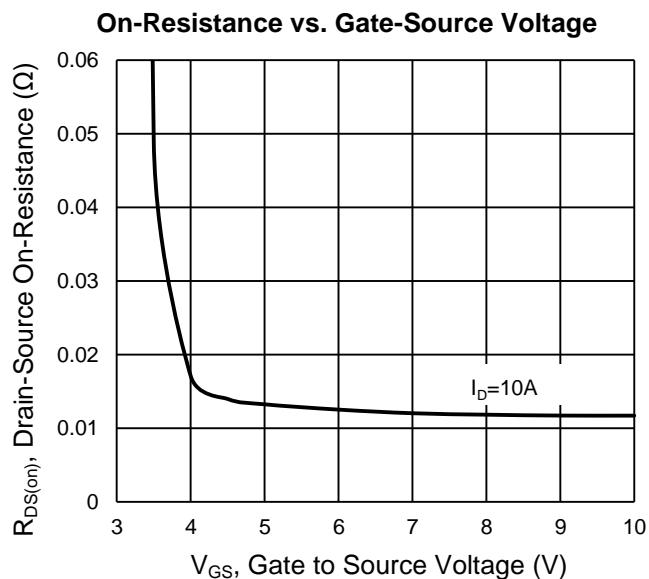
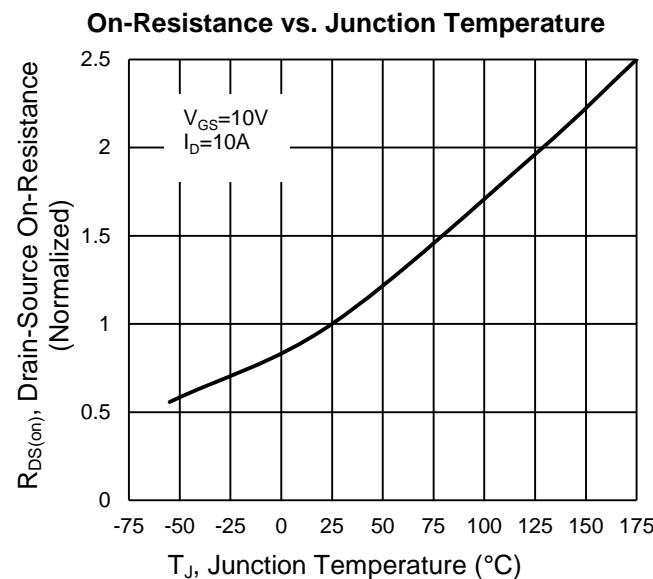
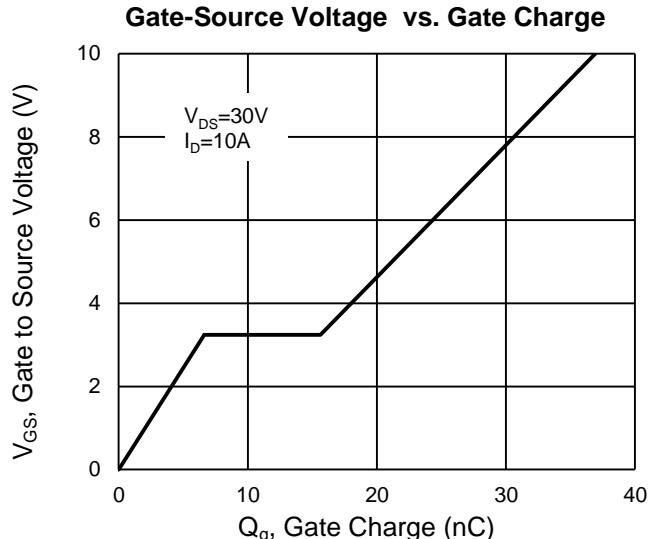
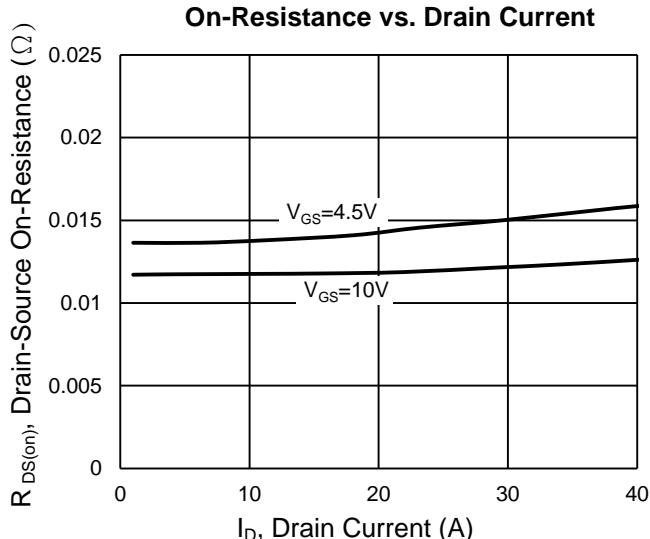
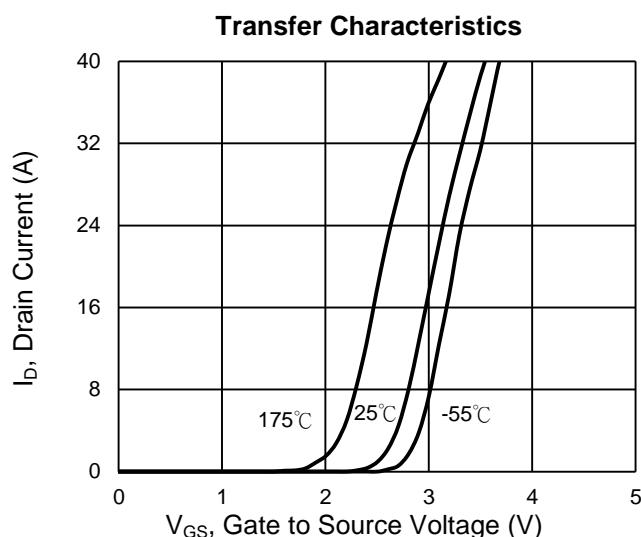
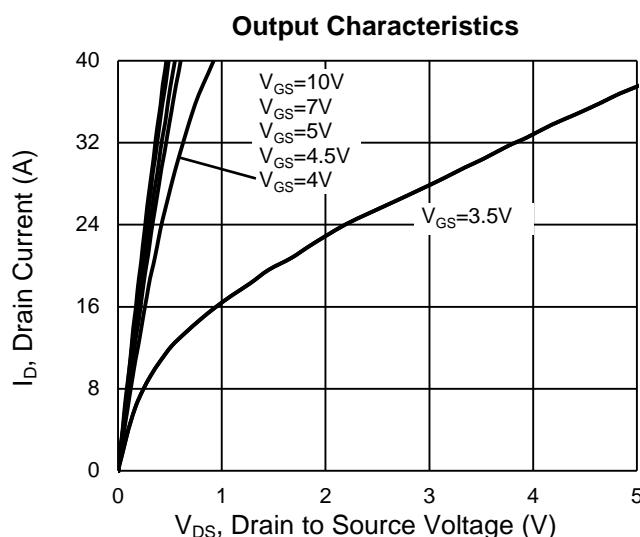
1. Silicon limited current only.
2. $L = 0.3\text{mH}$, $V_{GS} = 10\text{V}$, $V_{DD} = 30\text{V}$, $R_G = 25\Omega$, $I_{AS} = 20\text{A}$, Starting $T_J = 25^\circ\text{C}$
3. Pulse test: Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
4. Switching time is essentially independent of operating temperature.

ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM130NB06LCR RLG	PDFN56	2,500pcs / 13" Reel

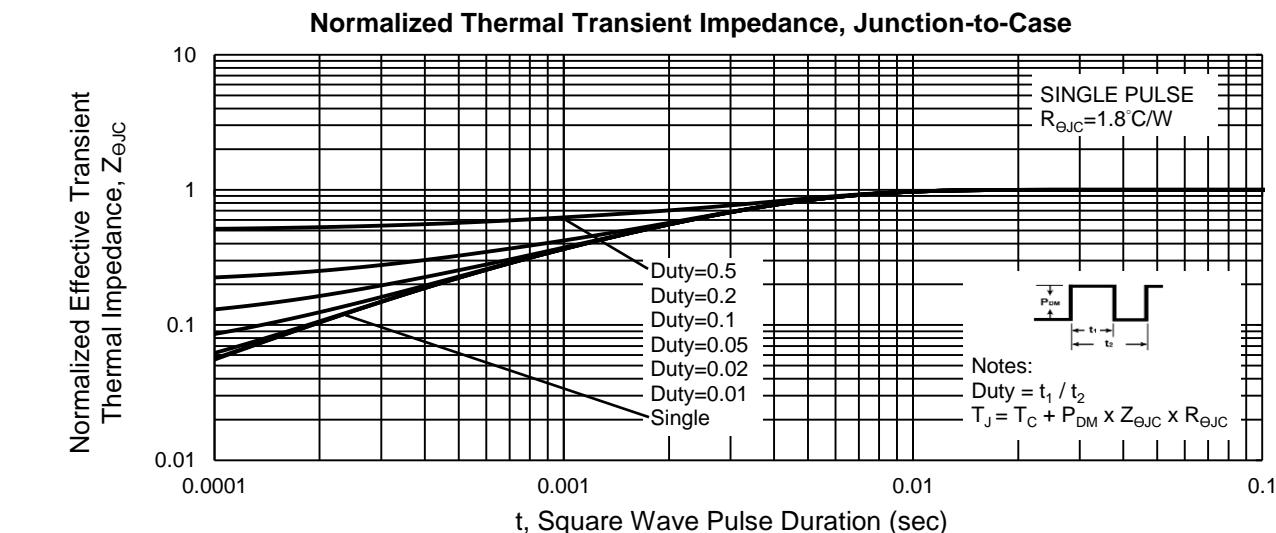
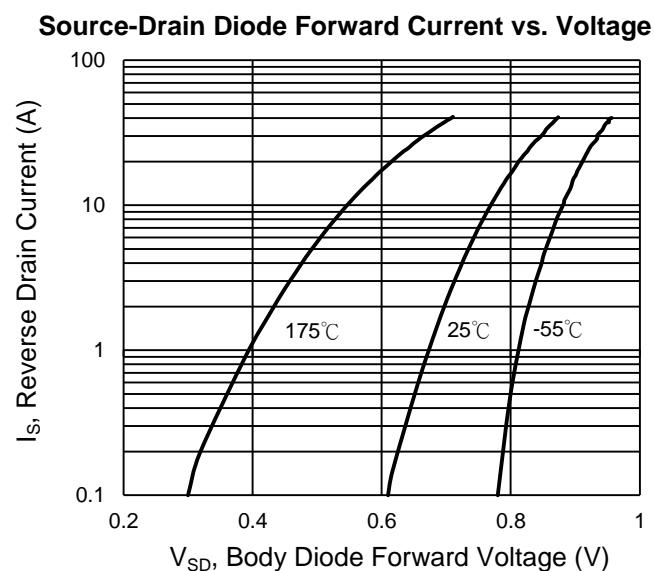
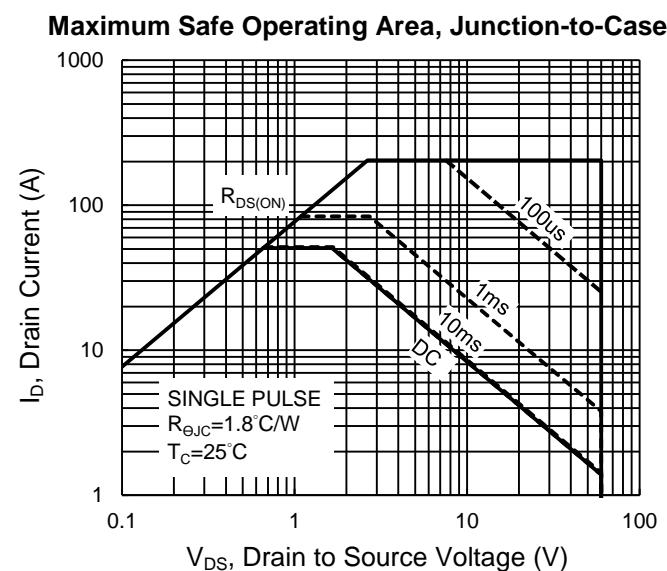
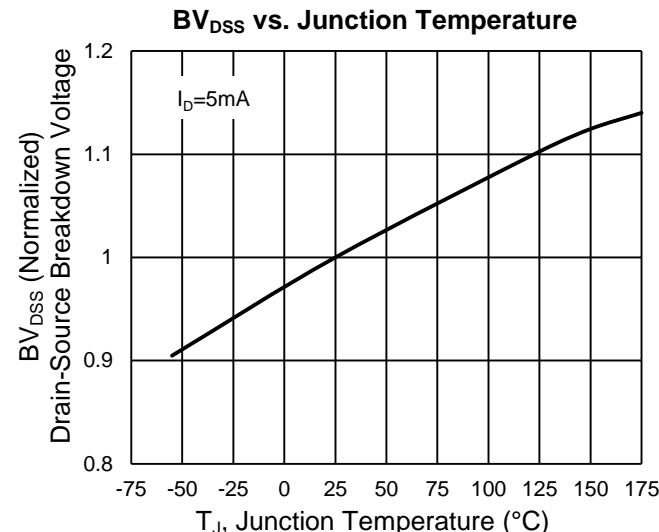
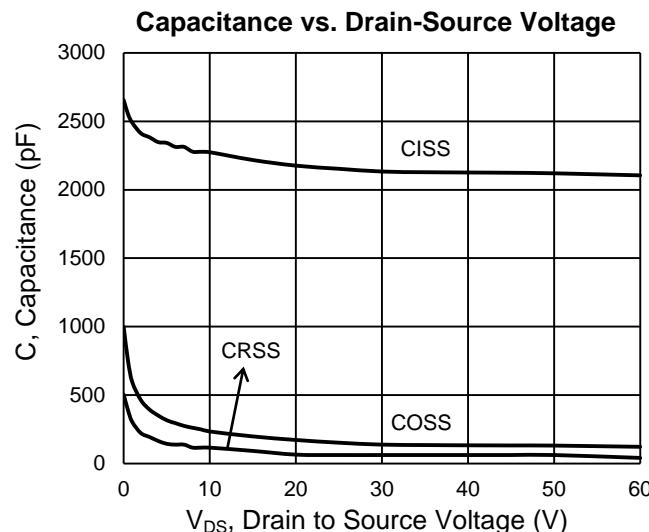
CHARACTERISTICS CURVES

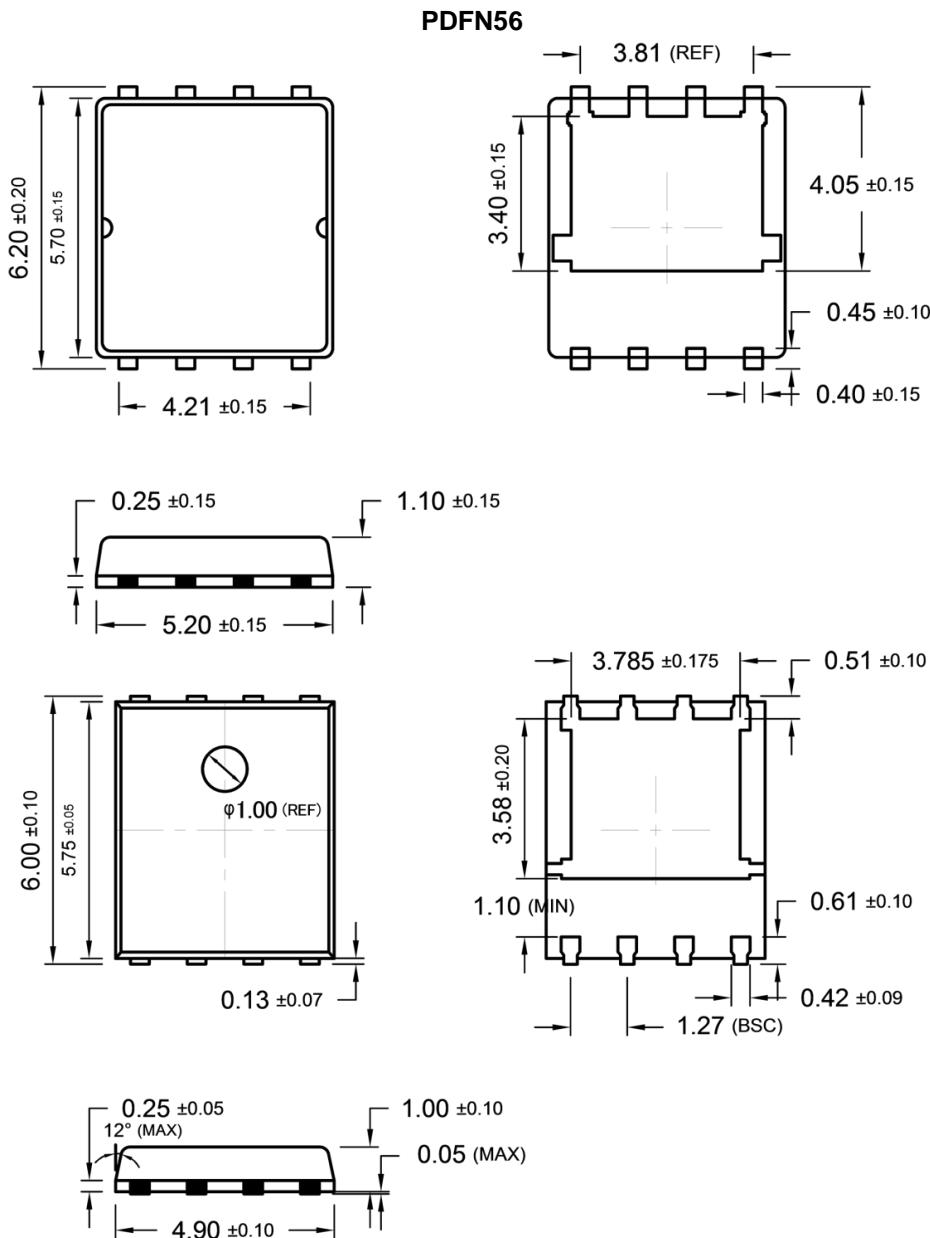
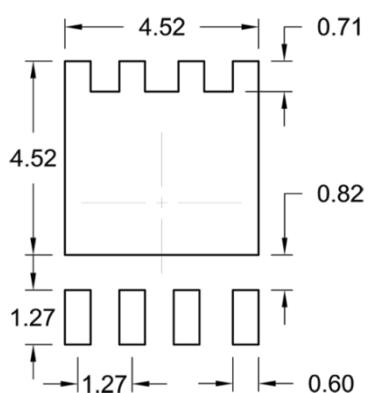
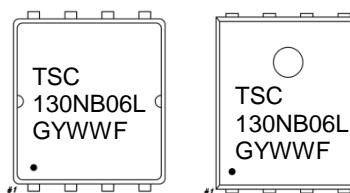
($T_A = 25^\circ\text{C}$ unless otherwise noted)



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SUGGESTED PAD LAYOUT (Unit: Millimeters)

MARKING DIAGRAM


G = Halogen Free
Y = Year Code
WW = Week Code (01~52)
F = Factory Code

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